



## INTRODUCTION

The Rockwell Single Chip (RSC) FORTH System can be configured using the R65F11, R65F12 microcomputers or the R6501Q ROM-less microcomputer. One of these microcomputers, when used in conjunction with a development ROM and a FORTH kernel ROM, provide the designer with maximum flexibility when developing FORTH applications.

RSC-FORTH is based on the popular fig-FORTH model with extensions. The R65F11 and R65F12 both have the kernel of the high level Rockwell Single Chip RSC-FORTH language contained in the preprogrammed ROM. The R65FK2 and R65FK3 Kernel ROMs are preprogrammed ROMs for use with the R6501Q when developing larger applications requiring more memory and I/O line support. All of the run time functions of the RSC-FORTH are contained in these ROMs, including 16- and 32-bit mathematical, logical and stack manipulation, plus memory and input/output operators. The RSC-FORTH Operating System allows an external user program written in RSC-FORTH or Assembly Language to be executed from external EPROM, or development of such a program under the control of the R65FR1, R65FR2 or R65FR3 RSC-FORTH Development ROMs.

This document describes five different RSC-FORTH system configurations using the development and kernel ROMs.

## ORDERING INFORMATION

| Part No.  | Description  |
|-----------|--|
| R65FR1P   | FORTH Development ROM for R65F11 or R65F12   |
| R65FR2P   | FORTH Development ROM for R6501Q   |
| R65FR3P   | FORTH Development ROM for R6501Q   |
| R65FK2P   | FORTH Kernel ROM for R6501Q  |
| R65FK3P   | FORTH Kernel ROM for R6501Q  |
| R65F11P   | 40-Pin FORTH Based Microcomputer at 1 MHz  |
| R65F11AP  | 40-Pin FORTH Based Microcomputer at 2 MHz  |
| R65F12Q   | 64-Pin FORTH Based Microcomputer at 1 MHz  |
| R65F12AQ  | 64-Pin FORTH Based Microcomputer at 2 MHz  |
| R6501Q    | 64-Pin One-Chip Microprocessor at 1 MHz  |
| R6501AQ   | 64-Pin One-Chip Microprocessor at 2 MHz  |
| Order No. | Description  |
| 2145      | R6501Q One-Chip Microprocessor Product Description                                 |
| 2146      | R65F11 and R65F12 FORTH Based Microcomputer Product Description                    |
| 2148      | RSC-FORTH User's Manual  |
| 2162      | Application Note: A Low-Cost Development Module for the R65F11 FORTH Microcomputer |

## FEATURES

- R65FR1 FORTH Development ROM
  - 8K ROM
  - Addressable from \$2000 through \$3FFF in FORTH development configuration memory map
  - R65F11 and R65F12 compatible
  - Operates in the R65F11/F12 FORTH development configuration
- R65FR2 FORTH Development ROM
  - 8K ROM
  - Addressable from \$4000 through \$5FFF in the FORTH development configuration memory map
  - R6501Q compatible for use in emulation of the R65F11/F12 FORTH development configuration
- R65FR3 FORTH Development ROM
  - 8K ROM
  - Addressable from \$C000 through \$DFFF in the FORTH development configuration memory map
  - Operates in the R6501Q FORTH development configuration
- R65FK2 FORTH Kernel ROM
  - 4K ROM
  - Addressable from \$F400 through \$FFFF in the FORTH development configuration memory map
  - R6501Q compatible for use in the emulation of the R65F11/F12 FORTH development configuration
  - Replaces the FORTH kernel contained in the R65F11 and R65F12 microcomputers during development
- R65FK3 FORTH Kernel ROM
  - 4K ROM
  - Addressable from \$F400 through \$FFFF in the FORTH development and production configuration memory maps
  - R6501Q compatible
  - Operates in the R6501Q FORTH development and production configurations

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## RSC-FORTH SYSTEM CONFIGURATIONS

The three configurations of the RSC-FORTH System are identified by the CPU-Development ROM combinations listed below:

RSC-FORTH System Configurations

| CPU    | Kernel ROM | Development ROM | RSC Configuration |
|--------|------------|-----------------|-------------------|
| R65F11 | none       | R65FR1          | 1                 |
| R65F12 | none       | R65FR1          | 1                 |
| R6501Q | R65FK2     | R65FR2          | 2                 |
| R6501Q | R65FK3     | R65FR3          | 3                 |

**RSC-FORTH CONFIGURATION 1 (R65FR1)****R65F11/R65F12 DEVELOPMENT AND PRODUCTION**

The RSC-FORTH Configuration 1 provides the designer with a FORTH development and application environment at a minimal cost. The application program is developed using an R65F11 or R65F12 microcomputer, an R65FR1 Development ROM and external RAM. Up to 8K bytes of RAM space is available using this configuration. However, Configuration 1 is limited to 5K or less bytes of RAM during development. This is the result of allocating 2K bytes of RAM for disk buffers and at least 1K bytes of RAM for the "Program heads". The program heads are contained in a dictionary containing the Name (NFA), Link Field Address (LFA) and the Parameter Field Address Pointer (PFA). This dictionary is a list of FORTH words and user-defined FORTH words used in the development of a FORTH program and is not present during the execution of the FORTH program.

Although programs may reside in the upper 8K bytes of memory area, normally filled by the R65FR1 Development ROM, it is difficult to develop code for that area using this configuration of the RSC-FORTH System.

The difference in using the R65F11 or the R65F12 is in the number of I/O lines available to the user. The R65F11 supports 16 I/O lines, the R65F12 supports 40 I/O lines.

Figure 1 shows the development and production configurations for the R65F11/F12. Configurations 1A and 1B list the features, memory maps, and the relationship of the R65F11 and R65F12 to the R65FR1 Development ROM in the development and production environment.

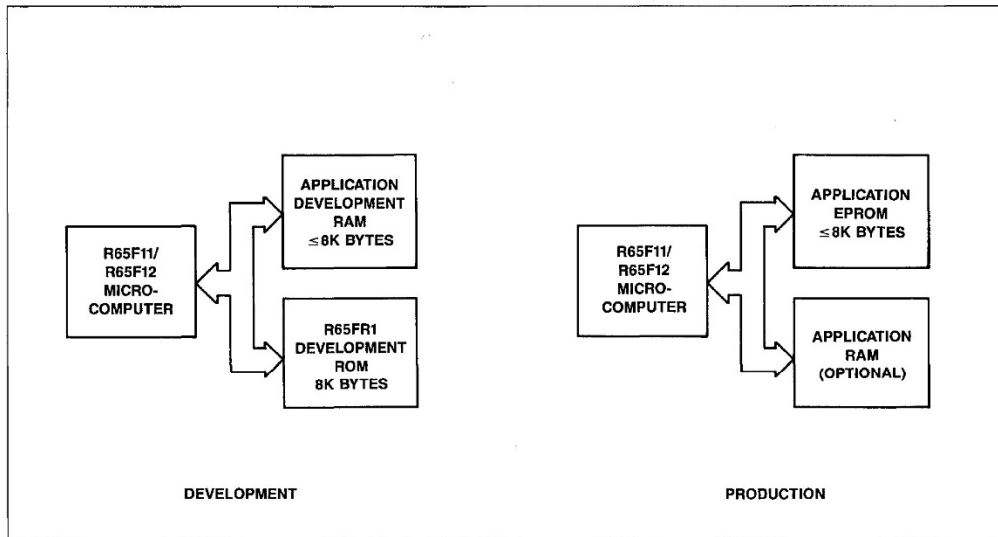


Figure 1. R65FR1 Configuration 1 Block Diagram

**CONFIGURATION 1A CONSIDERATIONS**

Features

- 8K Bytes of User Memory
- 16 I/O Lines

**Device Configuration**

|                        | DEVELOPMENT | PRODUCTION |
|------------------------|-------------|------------|
| R65F11 Microcomputer   | ✓           | ✓          |
| R65FR1 Development ROM | ✓           |            |

**CONFIGURATION 1B CONSIDERATIONS**

Features

- 8K Bytes of User Memory
- 40 I/O Lines

**Device Configuration**

|                        | DEVELOPMENT | PRODUCTION |
|------------------------|-------------|------------|
| R65F12 Microcomputer   | ✓           | ✓          |
| R65FR1 Development ROM | ✓           |            |

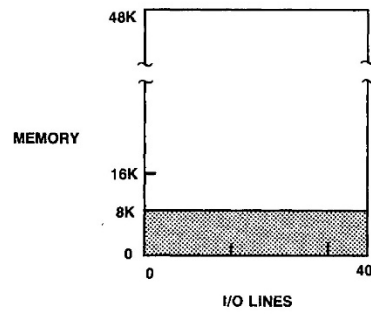
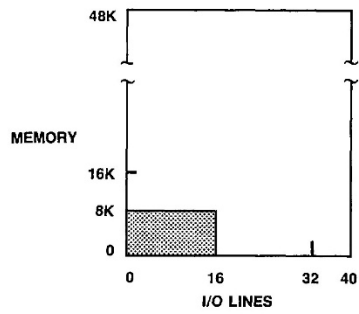
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**User Memory—I/O Resource Matrix**

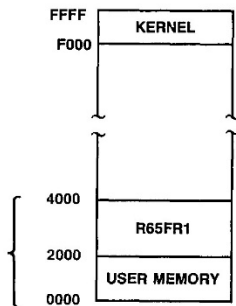
User memory may be a mix of ROM, EEROM, UVPPROM or RAM.

**User Memory—I/O Resource Matrix**

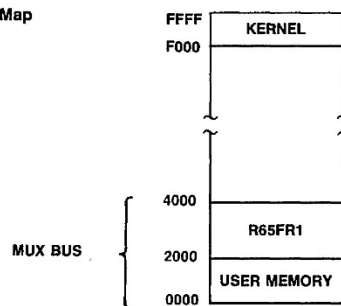
User memory may be a mix of ROM, EEROM, UVPPROM or RAM.



**Memory Map**



**Memory Map**



**RSC-FORTH CONFIGURATION 2  
(R65FR2, R65FK2)**

**R6501Q DEVELOPMENT AND R65F11/F12  
PRODUCTION**

The RSC-FORTH Configuration 2 provides the designer with the capability of using the full 16K bytes of external address space of the R65F11 and R65F12.

The R6501Q ROM-less microprocessor, when used with the R65FK2 Kernel ROM and the R65FR2 Development ROM, emulates the operation of the R65F11/F12. Because of the greater address space of the R6501Q, the R65FR2 Development ROM can be relocated to address \$4000 and the disk buffers and HEADS program to \$6000. This expands the available user memory space to 16K bytes, \$0000 through \$3FFF.

Using this configuration, the application program can be developed using the R6501Q and then later installed in an R65F11 or R65F12 microcomputer without modification.

Figure 2 shows the development and production configuration for the R6501Q. Configurations 2A and 2B list the features, memory maps, and the relationship of the R6501Q to the R65FR2 Development ROM and R65FK2 Kernel ROM in the development and production environment. Figure 3 is a schematic of the R6501Q, R65FR2, R65FK2 development setup designed to plug into a 40 pin socket in place of the R65F11.

**Note:** Ports E, F and G of the R65F12 are not present on the R6501Q and must be emulated by external TTL logic. Contact Rockwell for further information.

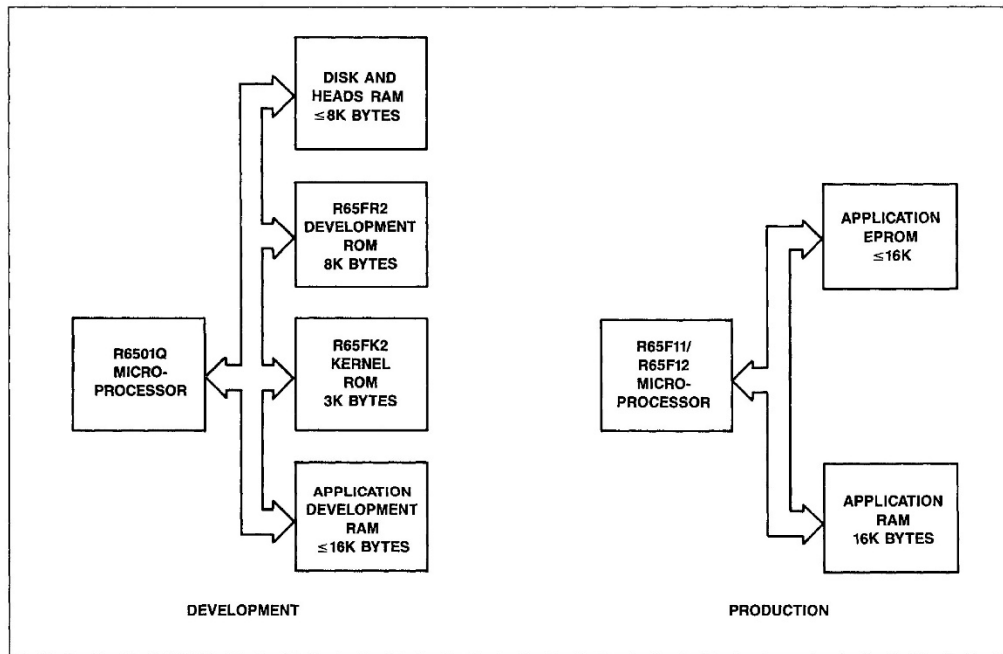


Figure 2. R65FR2 and R65FK2 Configuration 2 Block Diagrams

**CONFIGURATION 2A CONSIDERATIONS**

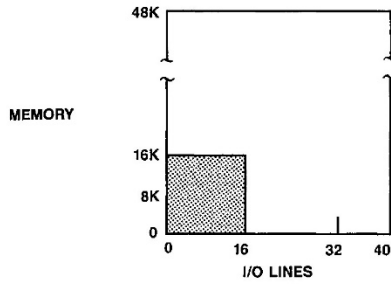
- Features
- 16K Bytes of User "Headerless" Memory
  - 16 I/O Lines

**Device Configuration**

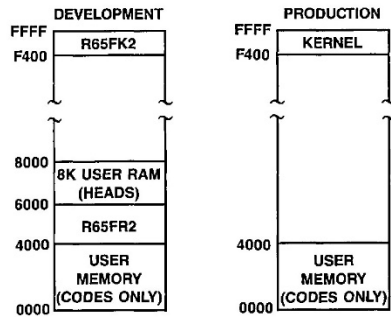
|                        | DEVELOPMENT | PRODUCTION |
|------------------------|-------------|------------|
| R65F11 Microcomputer   |             | ✓          |
| R6501Q Microprocessor  | ✓           |            |
| R65FR2 Development ROM | ✓           |            |
| R65FK2 Kernel ROM      | ✓           |            |

**Memory—I/O Matrix**

If floppy disk is used in the application, space for the disk buffers must be allocated in memory from \$0500 through \$3FFF or \$6000 through \$7FFF. User memory can be a mix of ROM, EEROM, UVROM or RAM.



**Memory Maps**



**CONFIGURATION 2B CONSIDERATIONS**

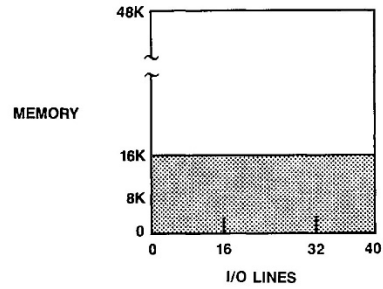
- Features
- 16K Bytes of User "Headerless" Memory
  - 40 I/O Lines

**Device Configuration**

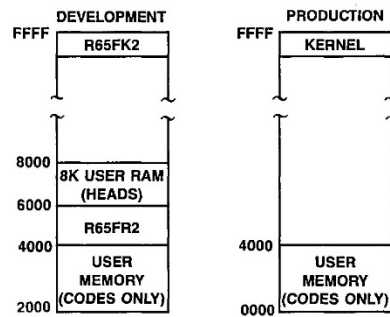
|                        | DEVELOPMENT | PRODUCTION |
|------------------------|-------------|------------|
| R65F12 Microcomputer   |             | ✓          |
| R6501Q Microprocessor  | ✓           |            |
| R65FR2 Development ROM | ✓           |            |
| R65FK2 Kernel ROM      | ✓           |            |

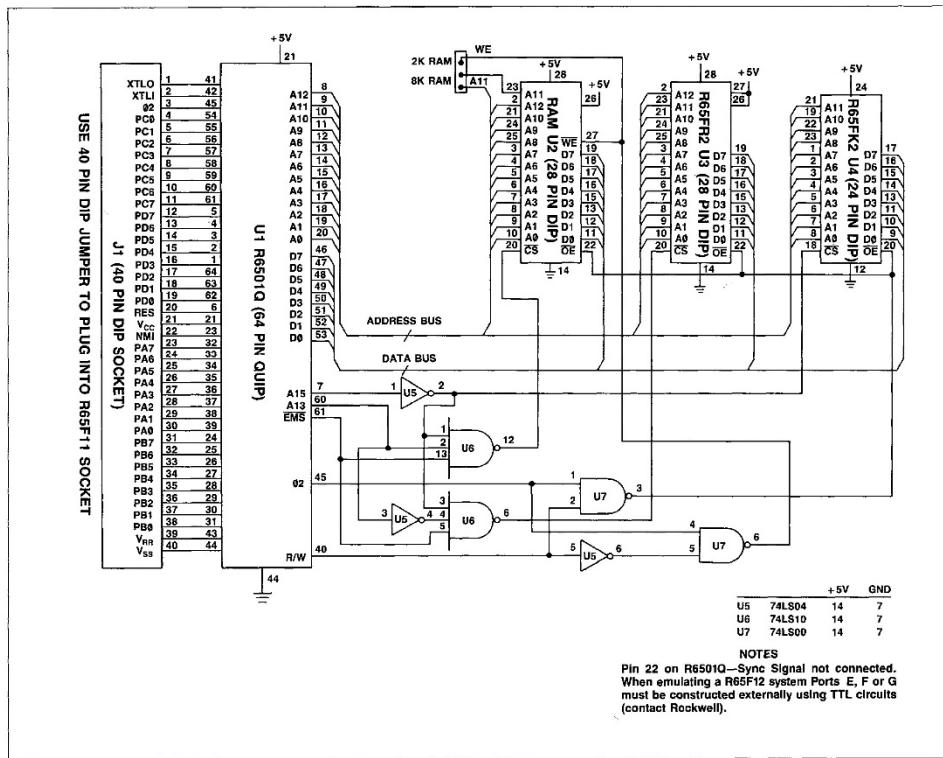
**Memory—I/O Matrix**

If floppy disk is used in the application, space for the disk buffers must be allocated in memory \$0000 through \$3FFF. User memory can be a mix of ROM, EEROM, UVROM or RAM.



**Memory Maps**





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Figure 3. R6501Q, R65FR2 and R65K2 Application Configuration Schematic

**RSC-FORTH CONFIGURATION 3  
(R65FR3, R65FK3)**

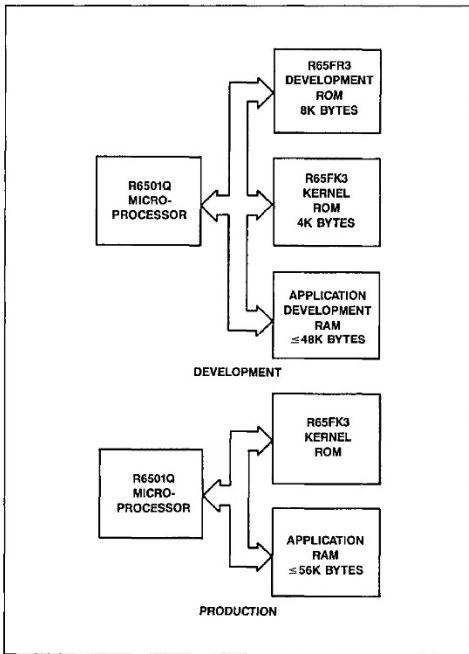
**R6501Q BASED SYSTEM DEVELOPMENT  
AND PRODUCTION**

The RSC-FORTH Configuration 3 is designed for those applications which require a larger amount of ROM or RAM space than the R65F11 or R65F12 can provide.

In the development configuration, the user is provided with up to 48K bytes of memory. The user memory is located from \$0000 through \$BFFF. The program heads will use some of this area but the user will still have considerably more memory space available than in the previous configurations.

The production configuration provides up to 56K bytes of user memory. This is due to the fact that the R65FR3 Development ROM, used in the development configuration, is not required in the production configuration and releases the 8K bytes of memory space. This memory is located at \$C000 through \$DFFF.

Figure 4 shows the development and production configurations for the R6501Q. Configuration 3 lists the features, memory maps, and the relationship of the R6501Q to the R65FR3 Development ROM and the R65FK3 Kernel ROM in the development and production environment.



**Figure 4. R65FR3 and R65FK3 Configuration 3 Block Diagrams**

**CONFIGURATION 3 CONSIDERATIONS**

**Features**

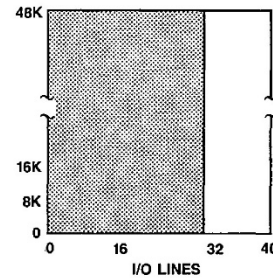
- R6501Q w/FORTH
- 48K Bytes of User Memory
- 30 I/O Lines

**Device Configuration**

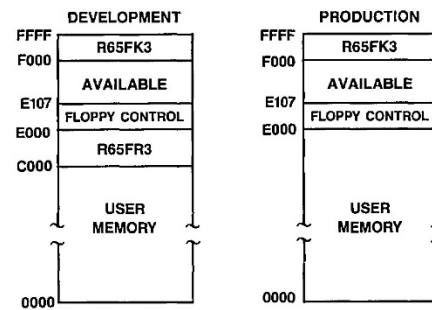
|                        | DEVELOPMENT | PRODUCTION |
|------------------------|-------------|------------|
| R6501Q Microcomputer   | ✓           | ✓          |
| R65FK3 Development ROM | ✓           |            |
| R65FR3 Kernel ROM      | ✓           | ✓          |

**User Memory—I/O Resource Matrix**

All ports act as I/O ports. Memory is on the bus. PC6 & PC7 (I/O lines) are assigned to memory. User memory can be a mix of ROM, EEROM, UVPRM or RAM.

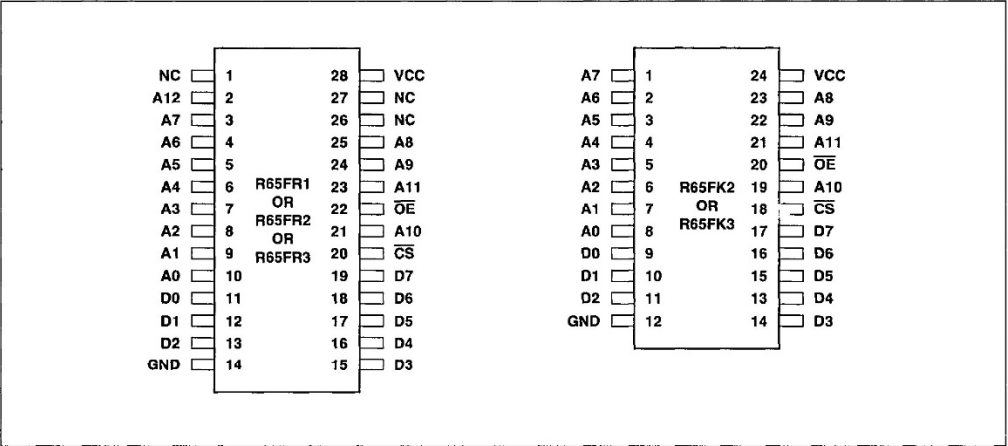


**Memory Maps**



Note: Chip select for the Floppy Disk Controller should be at \$E000-\$E006 and at \$E100-\$E106 for this configuration.

**3**



RSC-FORTH ROM Pin Assignments



**ABSOLUTE MAXIMUM RATINGS\***

R65FR1, R65FR2, R65FR3, R65FK2, R65FK3

| Parameter                   | Symbol          | Value        | Unit |
|-----------------------------|-----------------|--------------|------|
| Supply Voltage              | V <sub>CC</sub> | -0.5 to +7.0 | V    |
| Input Voltage               | V <sub>IN</sub> | -0.5 to +7.0 | V    |
| Operating Temperature Range | T <sub>A</sub>  | 0 to +70     | °C   |
| Storage Temperature         | T <sub>ST</sub> | -65 to +150  | °C   |
| Power Dissipation           | P <sub>D</sub>  | 1.0          | W    |

\*NOTE: Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the other sections of this document is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**OPERATING CONDITIONS**

| Parameter                    | Range      |
|------------------------------|------------|
| V <sub>CC</sub> Power Supply | 5.0V ± 5%  |
| Operating Temperature        | 0°C to 70° |

**3****D.C. CHARACTERISTICS**V<sub>CC</sub> = 5.0V ± 5%, T<sub>A</sub> = 0°C to +70°C (unless otherwise specified)

| Symbol          | Parameter                                | Min  | Typ      | Max             | Units    | Test Conditions  |
|-----------------|--|------|----------|-----------------|----------|--|
| V <sub>OH</sub> | Output High Voltage<br>R65FRx<br>R65FKx  | 2.4  | —        | V <sub>CC</sub> | V        | V <sub>CC</sub> = 4.75V<br>I <sub>OH</sub> = -400 μA<br>I <sub>OH</sub> = -240 μA        |
| V <sub>OL</sub> | Output Low Voltage<br>R65FRx<br>R65FKx   | —    | —        | 0.4             | V        | V <sub>CC</sub> = 4.75V<br>I <sub>OL</sub> = 3.3 mA<br>I <sub>OL</sub> = 2.1 mA          |
| V <sub>IH</sub> | Input High Voltage                       | 2.0  | —        | V <sub>CC</sub> | V        |  |
| V <sub>IL</sub> | Input Low Voltage                        | -0.5 | —        | 0.8             | V        |  |
| I <sub>LI</sub> | Input Load Current                       | —    | —        | 10              | μA       | V <sub>CC</sub> = 5.25V, 0V ≤ V <sub>IN</sub> ≤ 5.25V                                    |
| I <sub>LO</sub> | Output Leakage Current                   | —    | —        | ± 10            | μA       | Chip Deselected,<br>V <sub>CC</sub> = 5.25V, V <sub>OUT</sub> = +0.4V to V <sub>CC</sub> |
| I <sub>CC</sub> | Power Supply Current<br>R65FRx<br>R65FKx | —    | 25<br>80 | 55<br>135       | mA<br>mA | V <sub>CC</sub> = 5.25V @ 0°C  |
| C <sub>I</sub>  | Input Capacitance                        | —    | —        | 7               | pF       | V <sub>CC</sub> = 5.0V, Chip Deselected,<br>pin under test at 0V                         |
| C <sub>O</sub>  | Output Capacitance                       | —    | —        | 10              | pF       | V <sub>CC</sub> = 5.0V, Chip Deselected,<br>pin under test at 0V                         |